HEWLETT® PACKARD

C-Band Internally-Matched Power GaAs FETs (IMFETs) 6.4 to 7.2 GHz

Technical Data

IM6472-4L
IM6472-8L
IM6472-16L
IM6472-32L

Features

- **High Output Power:**
  - **IM6472-4L: 36.5 dBm typ. (4.5W)**
  - **IM6472-8L: 39.5 dBm typ. (9W)**
  - **IM6472-16L: 42.5 dBm typ. (18W)**
  - **IM6472-32L: 45.0 dBm typ. (32W)**
- **High Power-Added Efficiency: Up to 40%**
- **High Linearity: -45 dBc IMD_3 @ Specified Output Single Carrier Level**
- **Superior Gain Flatness: ± 0.5 dB max.**
- **Linear, Class A Operation**
- **Input and Output Internally Matched To 50 Ohms**
- **Industry Compatible Packages**

Applications

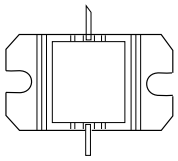
- **Solid State Power Amplifiers for Satellite Earth Station Uplink**
- **Digital Point-to-Point and Point-to-Multipoint Communications**

Description

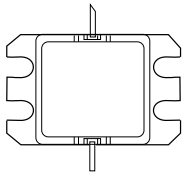
The Hewlett-Packard IM6472-xL series of internally-matched GaAs power FETs, or IMFETs™ is designed to provide efficient power amplification in the 6.4 to 7.2 GHz communications band. Designed for SatCom and Point-to-Point Radio communications, these products offer the system designer benefits associated with higher output power, gain, and net power-added efficiency.[1] Typical output power of the IM6472-4L exceeds 4 watts, with similar performance advantages for the IM6472-8L, -16L and -32L models. Higher levels of gain and operating efficiency are the result of leading edge GaAs MESFET technology developed at HP.

HP IMFETs are manufactured using hybrid construction techniques, combining GaAs power MESFETs with low loss, thin-film substrates. Internal 50 ohm matching networks eliminate the RF matching, handling, and die attach difficulties usually associated with using large geometry, high power chip devices. Automated assembly and test procedures provide excellent unit-to-unit repeatability and uniformity for easier cascading. HP IMFETs are housed in copper/ceramic packages to allow for maximum heat transfer from the GaAs FET device to the heatsink. The sealing process used is a commercial standard, non-hermetic epoxy, proven for environmental protection. Each unit conforms to the industry's standard outline dimensions. Electrical performance is guaranteed at +25°C.

C21A



C24A



Note:
1. Net power added efficiency = $(P_{out} - P_{in})/(I_{ds} \times V_{ds})$, where P_{out} and P_{in} are in watts.

IM6472-xL Absolute Maximum Ratings (T_{Flange}= 25ºC)

Symbols	Parameters	Units	Ratings			
			IM6472-4L	IM6472-8L	IM6472-16L	IM6472-32L
V_{DS}	Drain to Source Voltage	V	15	15	15	15
V_{GS}	Gate to Source Voltage	V	-10	-10	-10	-10
V_{GD}	Gate to Drain Voltage	V	-15	-15	-15	-15
I_{DS}	Drain Current	A	I_{DSS}	I_{DSS}	I_{DSS}	I_{DSS}
I_{GRF}	Gate Current	mA	±25	±50	±100	±200
T_{CH}	Max. Channel Temperature	ºC	175	175	175	175
T_{STG}	Storage Temperature	ºC	-65 to +150	-65 to +150	-65 to +150	-65 to +150
P_T [1]	Total Power Dissipation	W	31	38	83	150

IM6472-xL Electrical Characteristics (T_{Flange} = 25ºC)

	Part Number		IM6472-4L			IM6472-8L			
Symbols	Parameters	Units	Min.	Typ.	Max.	Min.	Typ.	Max.	Test Conditions
P1dB	Output Power @ 1 dB Gain Compression I_{DSQ} = 1.0 A I_{DSQ} = 2.0 A	 dBm dBm	 36.0	 36.5		 39.0	 39.5		V_{DS} = 10.0 V Freq.= 6.4 – 7.2 GHz Zs = Zl = 50 ohms R_G = 20 Ω
ηADD	Power-Added Efficiency @ 1 dB Gain Compression	%		40			38		
I_{DS}	Drain Current @ P1dB	A		1.1	1.5		2.2	3.0	
G1dB	Power Gain @ 1 dB Gain Compression	dB	8.5	9.5		7.5	8.5		
ΔG	Gain Flatness	dB		±0.3	±0.5		±0.3	±0.5	
IMD_3	3rd Order Intermod Distortion P_{out} SCL [2] I_{DSQ} 26 dBm 1.0 A 29 dBm 2.0 A	 dBc dBc		 -45	 -42		 -45	 -42	V_{DS} = 10.0 V Two Equal Tone Test f_1 = 7.19 GHz f_2 = 7.20 GHz
I_{DSS}	Saturated Drain Current	A	1.5	2.5	3.5	3.0	5.0	7.0	V_{GS} = 0 V; V_{DS} = 2.5 V
V_P	Pinch Off Voltage I_{DS} = 63 mA I_{DS} = 125 mA	 V V	 -4.5	 -3.0	 -1.5	 -4.5	 -3.0	 -1.5	V_{DS} = 2.5 V
BV_{GDO}	Gate-Drain Breakdown Voltage I_{GD} = -6 mA I_{GD} = -12 mA	 V V	 -16.0			 -16.0			
g_m	Transconductance I_{DS} = 1.0 A I_{DS} = 2.0 A	 S S		 1.3			 2.5		V_{DS} = 2.5 V
R_{TH}	Thermal Resistance (Channel to Flange)	ºC/W		4.9			4.0		I. R. Method; V_{DS} = 10.0 V I_{DS} = 1 and 2 A
ΔT	Temperature Rise Channel to Flange; DC on and RF off	ºC		49			80		I. R. Method
	Case Style		C21A						

Notes:
1. See Application Note, AN 1083
2. SCL: Single Carrier Level

IM6472-xL Electrical Characteristics (T_{Flange} = 25ºC)

	Part Number		IM6472-16L			IM6472-32L			
Symbols	**Parameters**	**Units**	**Min.**	**Typ.**	**Max.**	**Min.**	**Typ.**	**Max.**	**Test Conditions**
P1dB	Output Power @ 1 dB Gain Compression I_{DSQ} = 4.0 A I_{DSQ} = 8.0 A	 dBm dBm	 41.5	 42.5		 44.5	 45.0		V_{DS} = 10.0 V Freq.= 6.4 – 7.2 GHz Zs = Zl = 50 ohms R_G = 5 Ω
ηADD	Power-Added Efficiency @ 1 dB Gain Compression	%		37			31		
I_{DS}	Drain Current @ P1dB	A		4.4	6.0		8.8	12.0	
G1dB	Power Gain @ 1 dB Gain Compression	dB	7.0	8.0		6.0	6.5		
ΔG	Gain Flatness	dB		±0.3	±0.5		±0.3	±0.5	
IMD_3	3rd Order Intermod Distortion P_{out} SCL [1] I_{DSQ} 31.5 dBm 4.0 A 34.5 dBm 8.0 A	 dBc dBc		 -45	 -42		 -45	 -42	V_{DS} = 10.0 V Two Equal Tone Test f_1 = 7.19 GHz f_2 = 7.20 GHz
I_{DSS}	Saturated Drain Current	A	6.0	10.0	14.0	12.0	20.0	28.0	V_{GS} = 0 V; V_{DS} = 2.5 V
V_P	Pinch Off Voltage I_{DS} = 250 mA I_{DS} = 500 mA	 V V	 -4.5	 -3.0	 -1.5	 -4.5	 -3.0	 -1.5	V_{DS} = 2.5 V
BV_{GDO}	Gate-Drain Breakdown Voltage I_{GD} = -25 mA I_{GD} = -50 mA	 V V	 -16.0			 -16.0			
g_m	Transconductance I_{DS} = 4.0 A I_{DS} = 8.0 A	 S S		 5.0			 10.0		V_{DS} = 2.5 V
R_{TH}	Thermal Resistance (Channel to Flange)	ºC/W		1.8			1.0		I. R. Method; V_{DS} = 10.0 V I_{DS} = 4 and 8 A
ΔT	Temperature Rise Channel to Flange; DC on and RF off	ºC		72			80		I. R. Method
	Case Style		C24A						

Note:
1. SCL: Single Carrier Level

IM6472-4L and -8L Typical Performance (T_{Flange} = 25ºC)

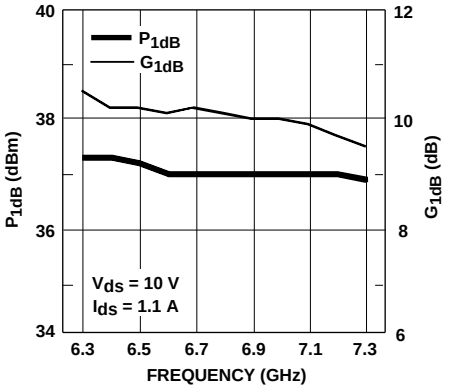


Figure 1. IM6472-4L Output Power, Gain vs. Frequency.

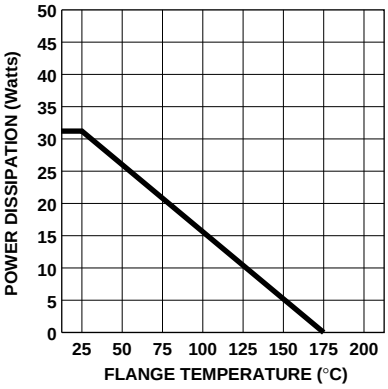


Figure 2. IM6472-4L Maximum Total Power Dissipation vs. Flange Temperature.

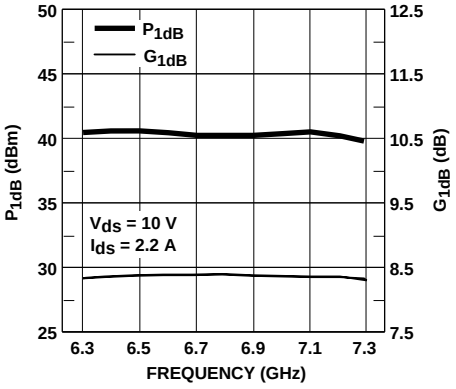


Figure 3. IM6472-8L Output Power, Gain vs. Frequency.

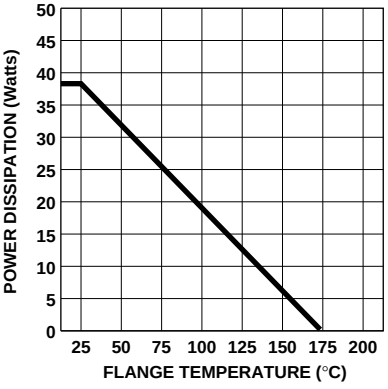


Figure 4. IM6472-8L Maximum Total Power Dissipation vs. Flange Temperature.

IM6472-16L and -32L Typical Performance (T_{Flange} = 25ºC)

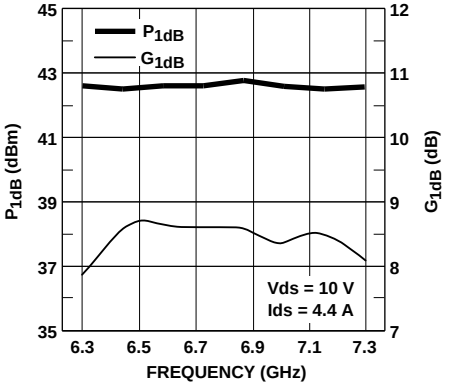


Figure 5. IM6472-16L Output Power, Gain vs. Frequency.

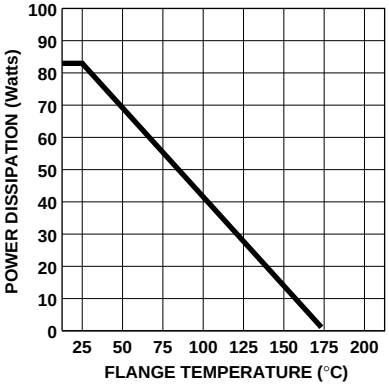


Figure 6. IM6472-16L Total Power Dissipation vs. Flange Temperature.

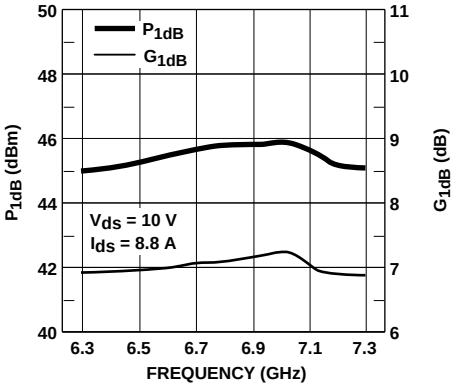


Figure 7. IM6472-32L Output Power, Gain vs. Frequency.

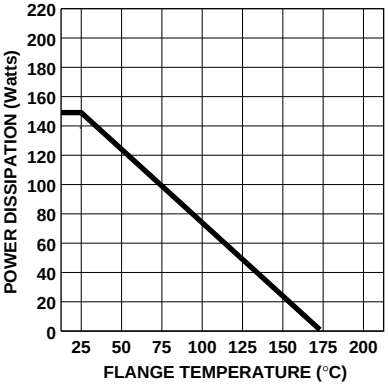
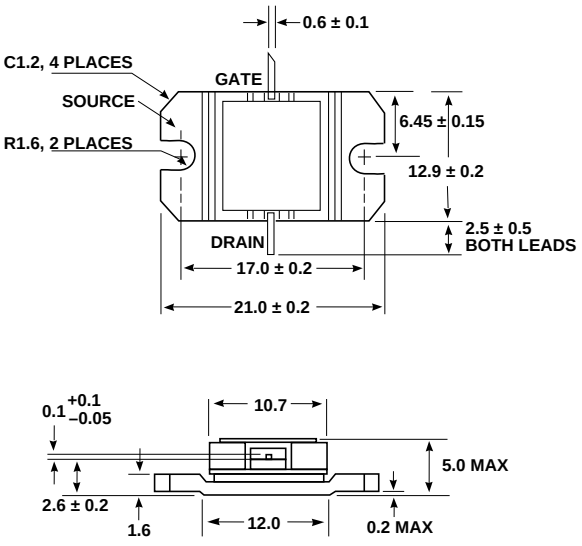


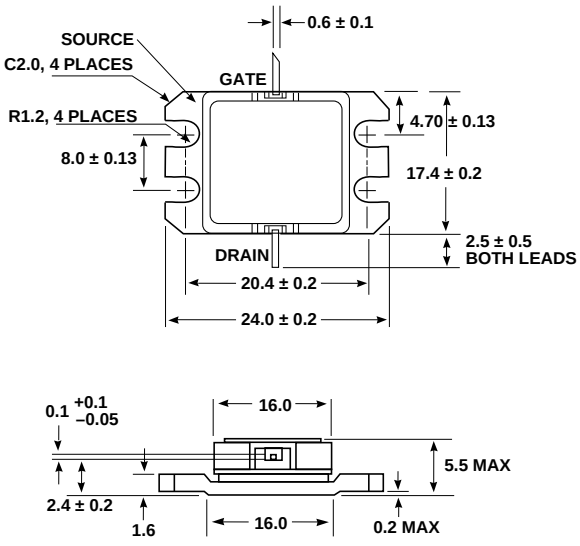
Figure 8. IM6472-32L Maximum Total Power Dissipation vs. Flange Temperature.

Case Dimensions

C21A Package Outline
IM6472-4L and IM6472-8L



C24A Package Outline
IM6472-16L and IM6472-32L



NOTES (UNLESS OTHERWISE SPECIFIED):
1. DIMENSIONS ARE SPECIFIED IN mm

For technical assistance or the location of your nearest Hewlett-Packard sales office, distributor or representative call:

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Data subject to change.

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